

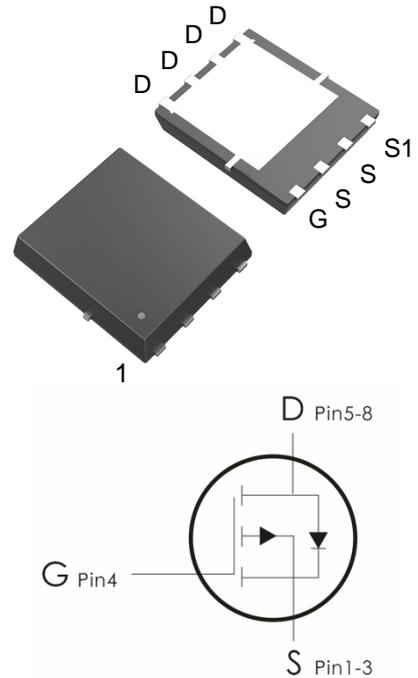
Description:

This P-Channel MOSFET uses advanced trench technology and design to provide excellent $R_{DS(on)}$ with low gate charge.

It can be used in a wide variety of applications.

Features:

- 1) $V_{DS}=-100V, I_D=-15A, R_{DS(ON)}<180m\ \Omega @V_{GS}=-10V$ (Typ: $142m\ \Omega$)
- 2) Low gate charge.
- 3) Green device available.
- 4) Advanced high cell density trench technology for ultra low $R_{DS(ON)}$.
- 5) Excellent package for good heat dissipation.
- 6) MSL3



Package Marking and Ordering Information:

Part NO.	Marking	Package	Packing
NH180PG-C	H180P-C	DFN5*6-8	5000 pcs/Reel

Absolute Maximum Ratings: ($T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Ratings	Units
V_{DS}	Drain-Source Voltage	-100	V
V_{GS}	Gate-Source Voltage	± 20	V
I_D	Continuous Drain Current	-15	A
	Continuous Drain Current- $T_C=100^\circ\text{C}$	-11	
I_{DM}	Pulsed Drain Current ¹	-60	
P_D	Total Power Dissipation	58	W
E_{AS}	Single Pulsed Avalanche Energy ²	68.6	mJ
T_J, T_{STG}	Operating and Storage Junction Temperature Range	-55 to +150	$^\circ\text{C}$

Thermal Characteristics:

Symbol	Parameter	Max	Units
$R_{\theta JC}$	Thermal Resistance, Junction to Case	2.1	$^\circ\text{C}/\text{W}$

Electrical Characteristics: ($T_C=25^\circ\text{C}$ unless otherwise noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_D=250\ \mu\text{A}$	-100	---	---	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{GS}=0V, V_{DS}=-100V$	---	---	-1	μA
I_{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm 20V, V_{DS}=0A$	---	---	± 100	nA
On Characteristics						
$V_{GS(th)}$	Gate-Source Threshold Voltage	$V_{GS}=V_{DS}, I_D=250\ \mu\text{A}$	-1	-1.7	-3	V
$R_{DS(on)}$	Drain-Source On Resistance ²	$V_{GS}=-10V, I_D=-8A$	---	142	180	$\text{m}\Omega$
		$V_{GS}=-4.5V, I_D=-6A$	---	155	200	$\text{m}\Omega$
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{DS}=-25V, V_{GS}=0V, f=1\text{MHz}$	---	1675	---	pF
C_{oss}	Output Capacitance		---	78	--	
C_{rss}	Reverse Transfer Capacitance		---	45	---	
Switching Characteristics						
$t_{d(on)}$	Turn-On Delay Time	$V_{DS}=-50V, I_D=-5A,$ $R_G=2.5\ \Omega, V_{GS}=-10V$	---	7.1	---	ns
t_r	Rise Time		---	9	---	ns
$t_{d(off)}$	Turn-Off Delay Time		---	51.5	---	ns
t_f	Fall Time		---	33.4	---	ns
Q_g	Total Gate Charge		---	28.5	---	nC
Q_{gs}	Gate-Source Charge	$V_{GS}=-10V, V_{DS}=-80V,$	---	4.8	---	nC
Q_{gd}	Gate-Drain "Miller" Charge	$I_D=-5A$	---	4.5	---	nC
Drain-Source Diode Characteristics						
V_{SD}	Diode Forward Voltage	$V_{GS}=0V, I_{SD}=-1A$	---	---	-1.3	V
I_S	Continuous Drain Current	$V_D=V_G=0V$	---	---	-15	A
I_{SM}	Pulsed Drain Current		---	---	-60	A
T_{rr}	Reverse Recovery Time	$I_F=5A, T_J=25^\circ\text{C}$	---	19.4	---	ns
Q_{rr}	Reverse Recovery Charge	$di/dt=100A/\mu\text{s}$	---	18.3	---	nC

Notes:

1. Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature
2. EAS condition : $T_J=25^{\circ}\text{C}$, $V_{DD}=-50\text{V}$, $V_G=10\text{V}$, $L=0.5\text{mH}$
3. Pulse Test: Pulse Width $\leq 300\mu\text{s}$, Duty Cycle $\leq 0.5\%$

Typical Characteristics: ($T_C=25^{\circ}\text{C}$ unless otherwise noted)

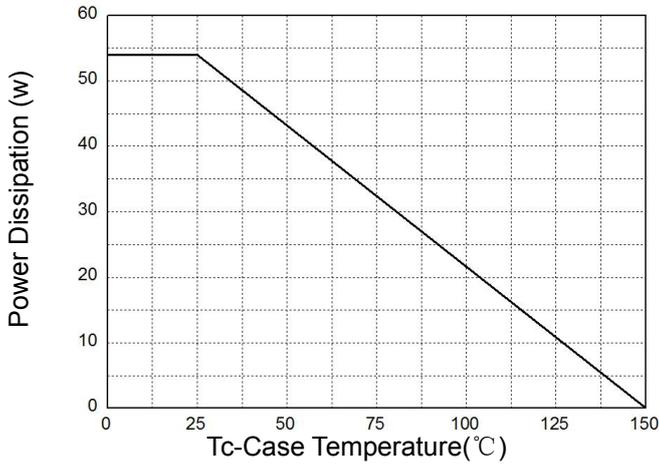


Figure 1: Power Dissipation

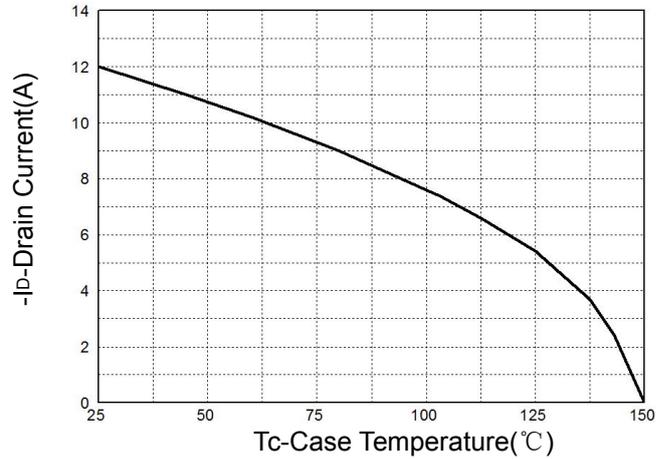


Figure 2: Drain Current

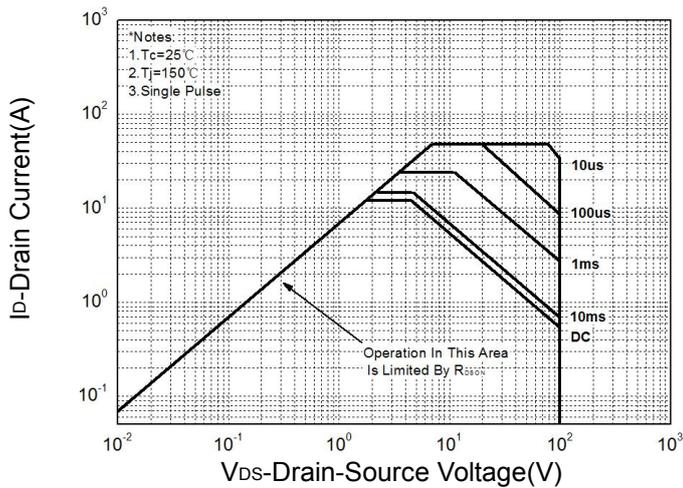


Figure 3: Safe Operation Area

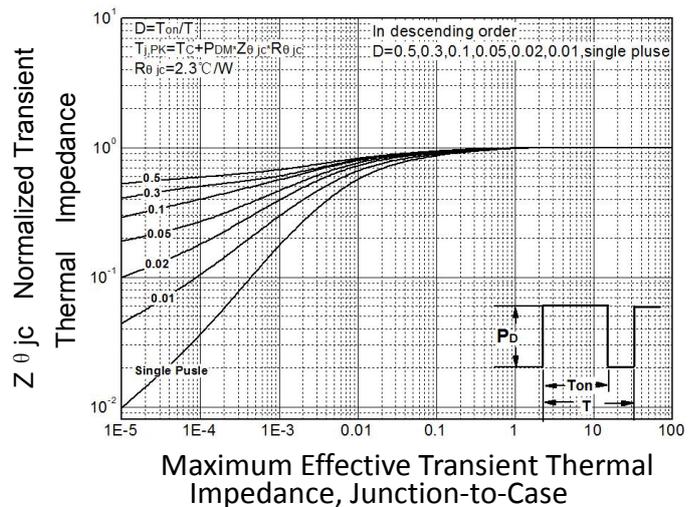


Figure 4: Thermal Transient Impedance

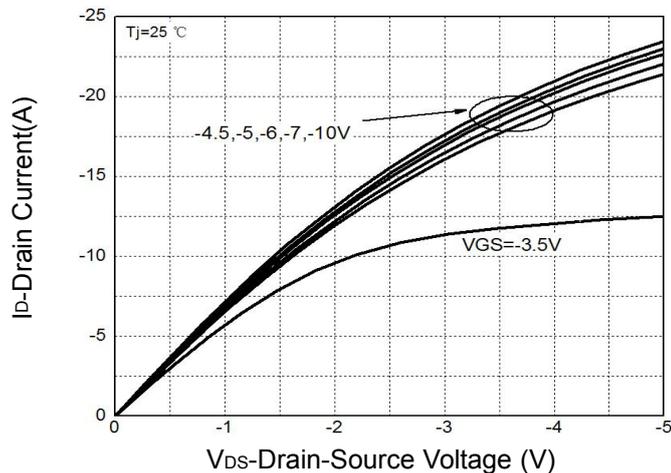


Figure 5: Output Characteristics

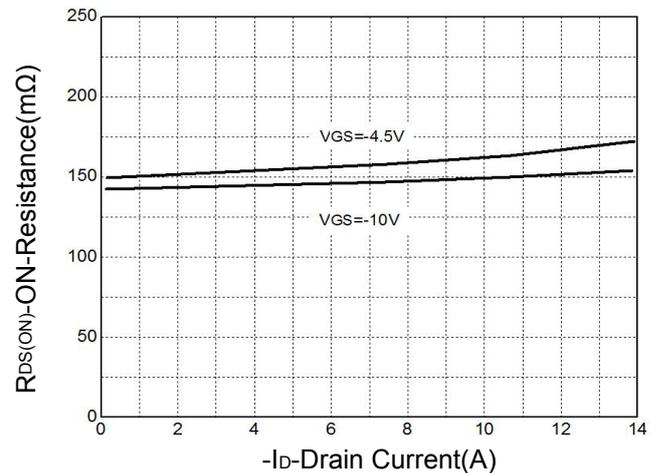


Figure 6: Drain-Source On Resistance

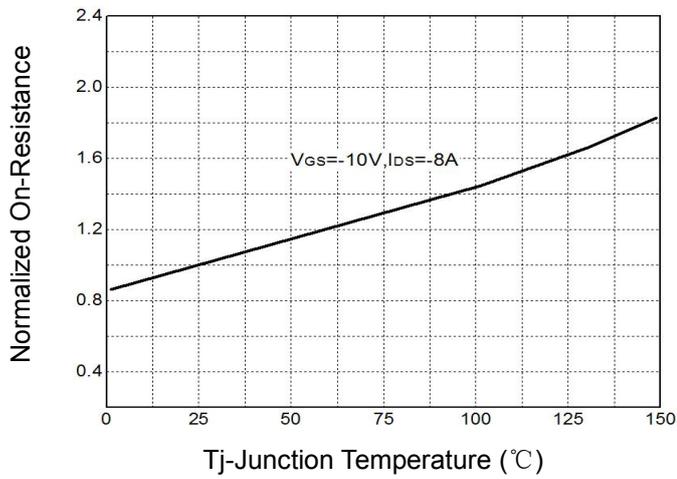


Figure 7: On-Resistance vs. Temperature

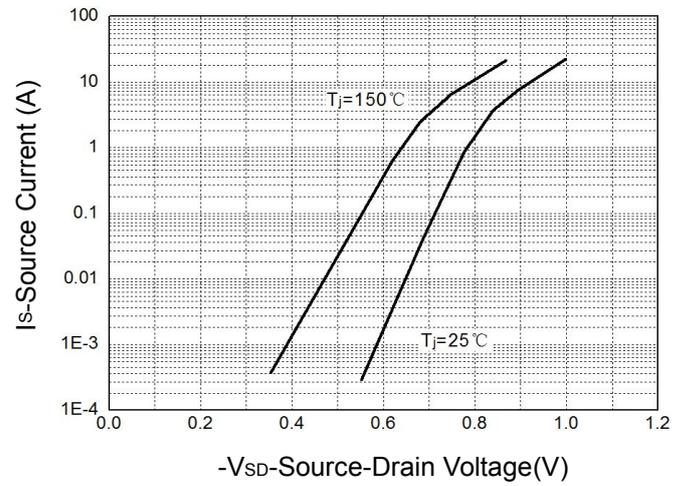


Figure 8: Source-Drain Diode Forward

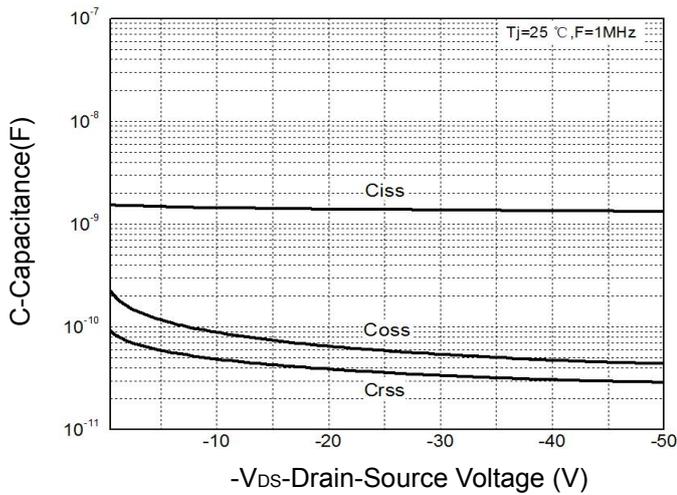


Figure 9: Capacitance Characteristics

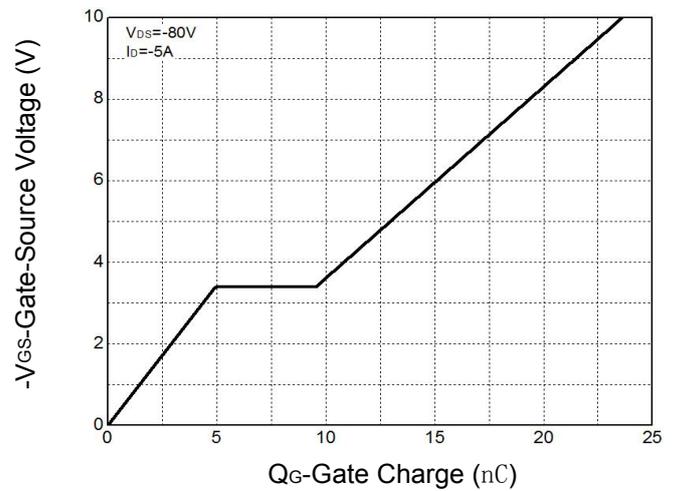
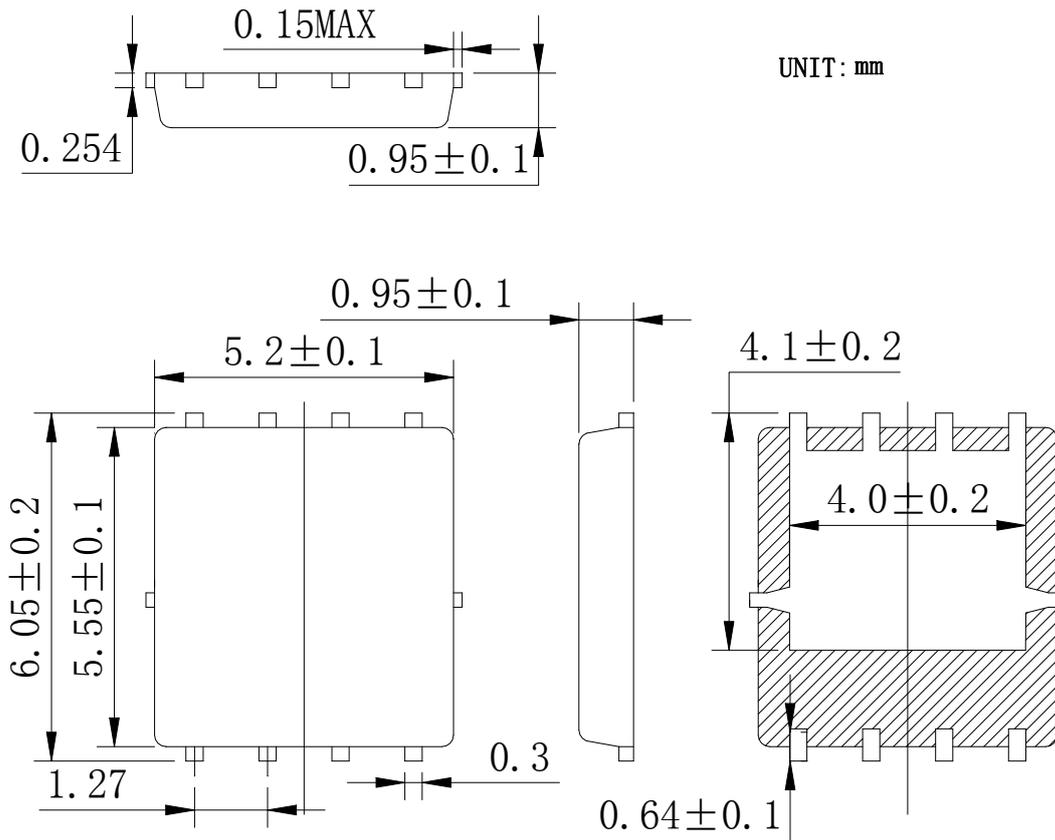


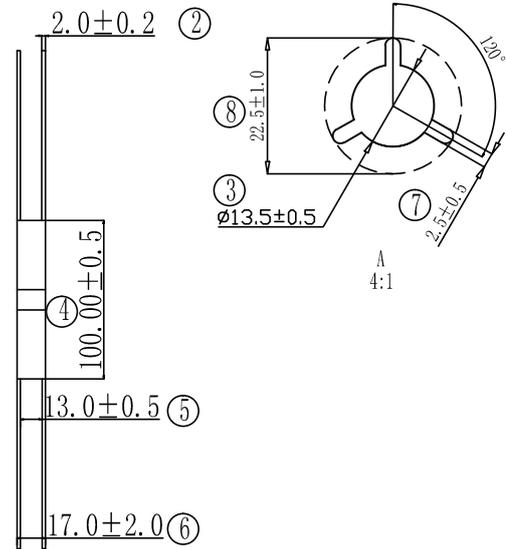
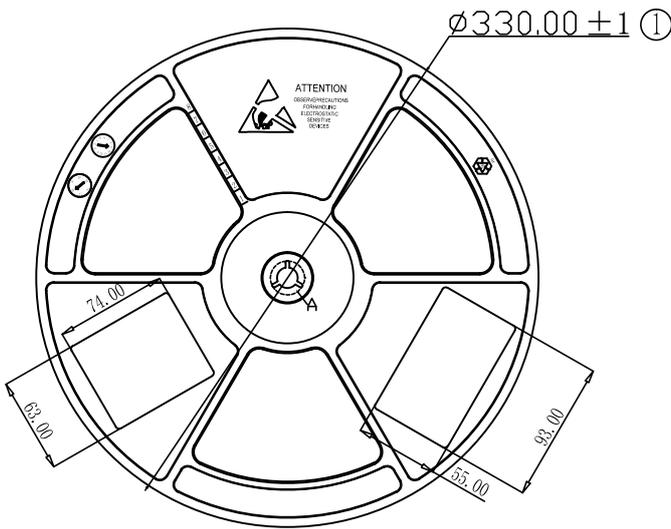
Figure 10: Gate Charge Characteristics

DFN5x6-8 Package Information:

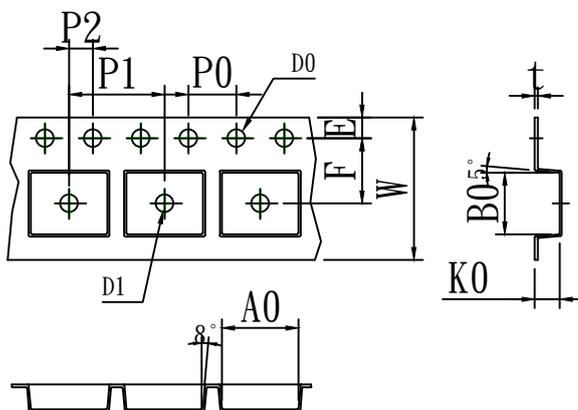


Tape & Reel Information

Dimensions in mm



Symbol	A0	B0	K0	D0	D1	P0	P1	10*P0
Spec	6.15 ± 0.10	5.40 ± 0.10	1.30 ± 0.10	1.55 ± 0.10	1.55 ± 0.10	4.00 ± 0.10	8.00 ± 0.10	40.00 ± 0.10
Symbol	W	E	F	P2	t			
Spec	12.00 ± 0.10	1.75 ± 0.10	5.50 ± 0.10	2.00 ± 0.10	0.20 ± 0.05			



Pulling direction 

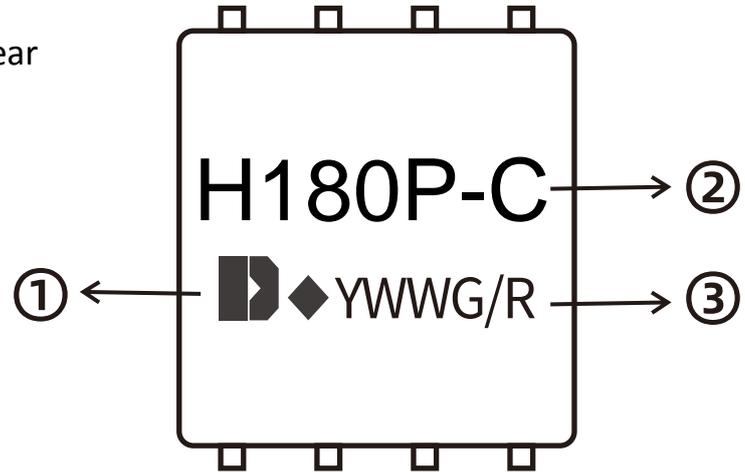
Marking Information:

- ①. Doingter LOGO
- ②. Part NO.
- ③. Date Code(YWWG / R)

Y : Year Code , last digit of the year

WW : Week Code(01-53)

G/R : G(Green) /R(Lead Free)



Previous Version

Version	Date	Subjects (major changes since last revision)
1.0	2024-09-12	Release of final version

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